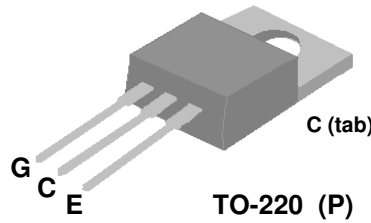


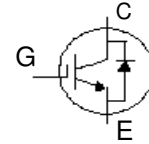


N-Channel Insulated Gate Bipolar Power Transistor

High Speed Switching
Low Saturation Voltage
Typical $V_{CE(sat)} = 1.7V$ at $I_C=19A$
Industry-standard TO-220 package
RoHS-compliant, halogen-free



V_{CES}	600V
I_C	19A



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{CES}	Collector-Emitter Voltage	600	V
V_{GE}	Gate-Emitter Voltage	± 20	V
I_C at $T_C=25^\circ C$	Collector Current	33	A
I_C at $T_C=100^\circ C$	Collector Current	19	A
I_{CM}	Pulsed Collector Current ¹	72	A
I_F at $T_C=100^\circ C$	Diode Forward Current	8	A
I_{FM}	Diode Pulse Forward Current	40	A
P_D at $T_C=25^\circ C$	Maximum Power Dissipation	78	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	150	$^\circ C$

Notes:

1. Pulse width limited by maximum junction temperature.

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Thermal Resistance Junction-Case	1.6	$^\circ C/W$
Rthj-c(Diode)	Thermal Resistance Junction-Case	2.4	$^\circ C/W$
Rthj-a	Thermal Resistance Junction-Ambient	62	$^\circ C/W$

Electrical Specifications at $T_J=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_{GES}	Gate-to-Emitter Leakage Current	$V_{GE}=\pm 20V, V_{CE}=0V$	-	-	± 100	nA
I_{CES}	Collector-Emitter Leakage Current	$V_{CE}=600V, V_{GE}=0V$	-	-	1	mA
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=19A$	-	1.7	2.2	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=25A$	-	1.9	-	V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{CE}=V_{GE}, I_C=250\mu A$	2	-	6	V
Q_g	Total Gate Charge	$I_C=20A$	-	95	150	nC
Q_{ge}	Gate-Emitter Charge	$V_{CC}=480V$	-	16	-	nC
Q_{gc}	Gate-Collector Charge	$V_{GE}=15V$	-	35	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{CE}=480V, I_C=20A,$	-	40	-	ns
t_r	Rise Time	$V_{GE}=15V,$	-	20	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=5\Omega,$	-	140	-	ns
t_f	Fall Time	Inductive Load	-	200	400	ns
E_{on}	Turn-On Switching Loss		-	0.1	-	mJ
E_{off}	Turn-Off Switching Loss		-	1	-	mJ
C_{ies}	Input Capacitance	$V_{GE}=0V$	-	2760	4400	pF
C_{oes}	Output Capacitance	$V_{CE}=30V$	-	65	-	pF
C_{res}	Reverse Transfer Capacitance	$f=1.0MHz$	-	40	-	pF
V_F	FRD Forward Voltage	$I_F=8A$	-	1.8	2.4	V
t_{rr}	FRD Reverse Recovery Time	$I_F=8A$	-	30	-	ns
Q_{rr}	FRD Reverse Recovery Charge	$di/dt = 100 A/\mu s$	-	30	-	nC

Ordering Information

AP20GT60ASP-HF-3TB : in RoHS-compliant halogen-free TO-220, shipped in tubes (50pcs/tube)

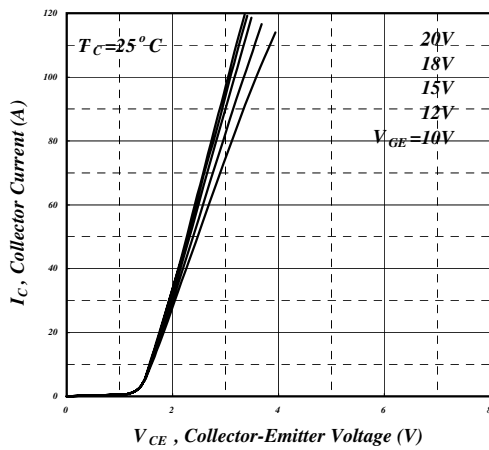


Fig 1. Typical Output Characteristics

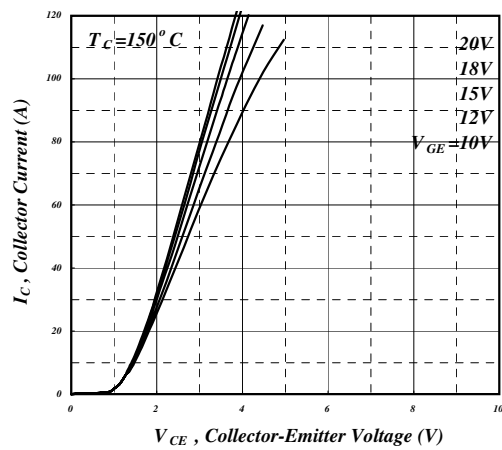


Fig 2. Typical Output Characteristics

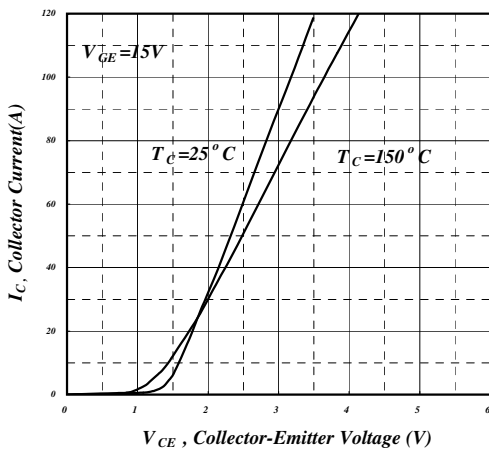


Fig 3. Typical Saturation Voltage Characteristics

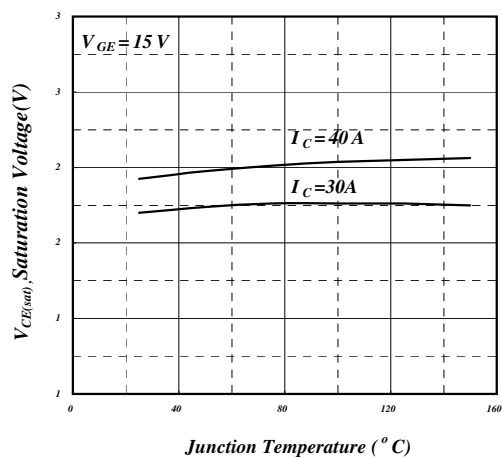


Fig 4. Typical Collector- Emitter Voltage vs. Junction Temperature

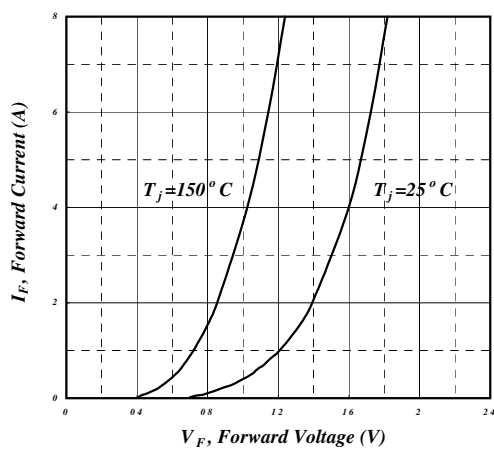


Fig 5. Forward Characteristics of the Diode

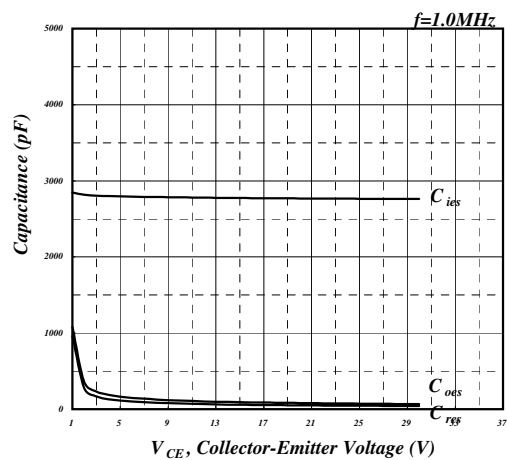


Fig 6. Typical Capacitance Characteristics

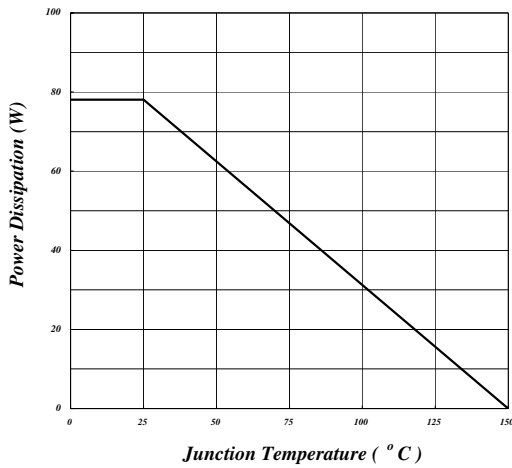


Fig 7. Power Dissipation vs. Junction Temperature

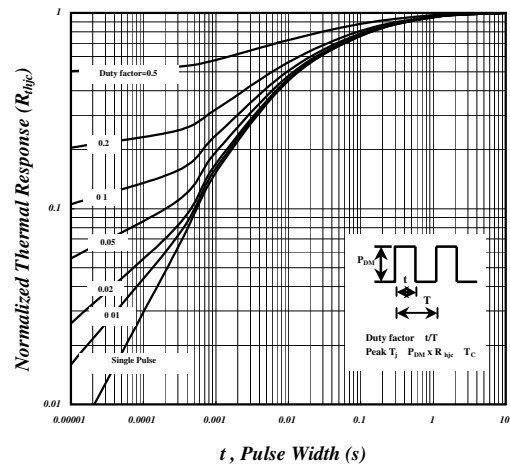


Fig 8. Effective Transient Thermal Impedance

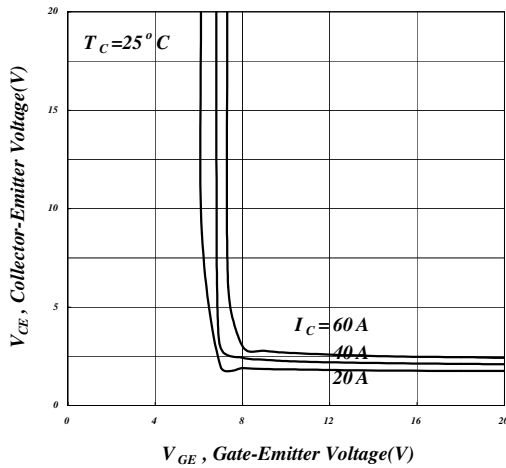


Fig 9. Saturation Voltage vs. V_{GE}

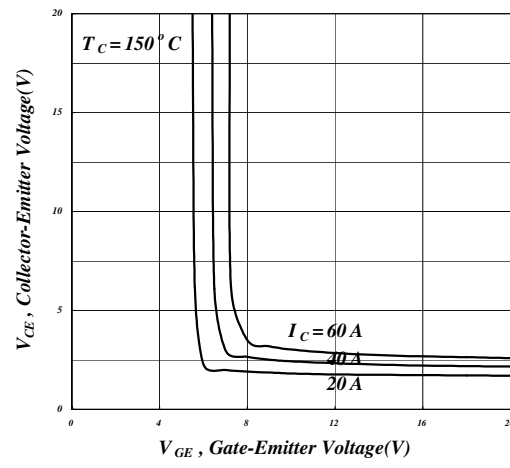


Fig 10. Saturation Voltage vs. V_{GE}

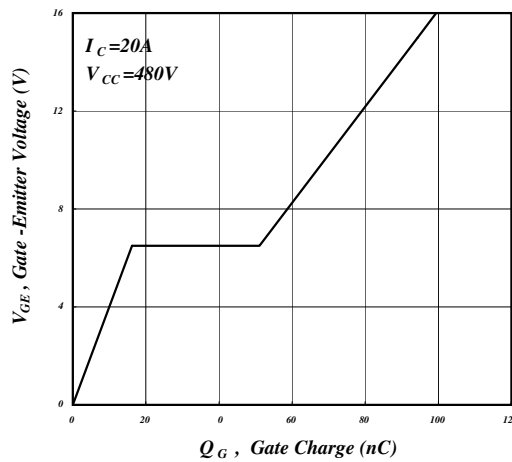


Fig 11. Gate Charge Characteristics

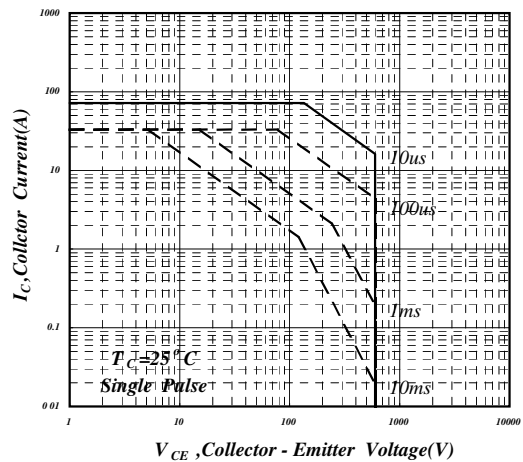
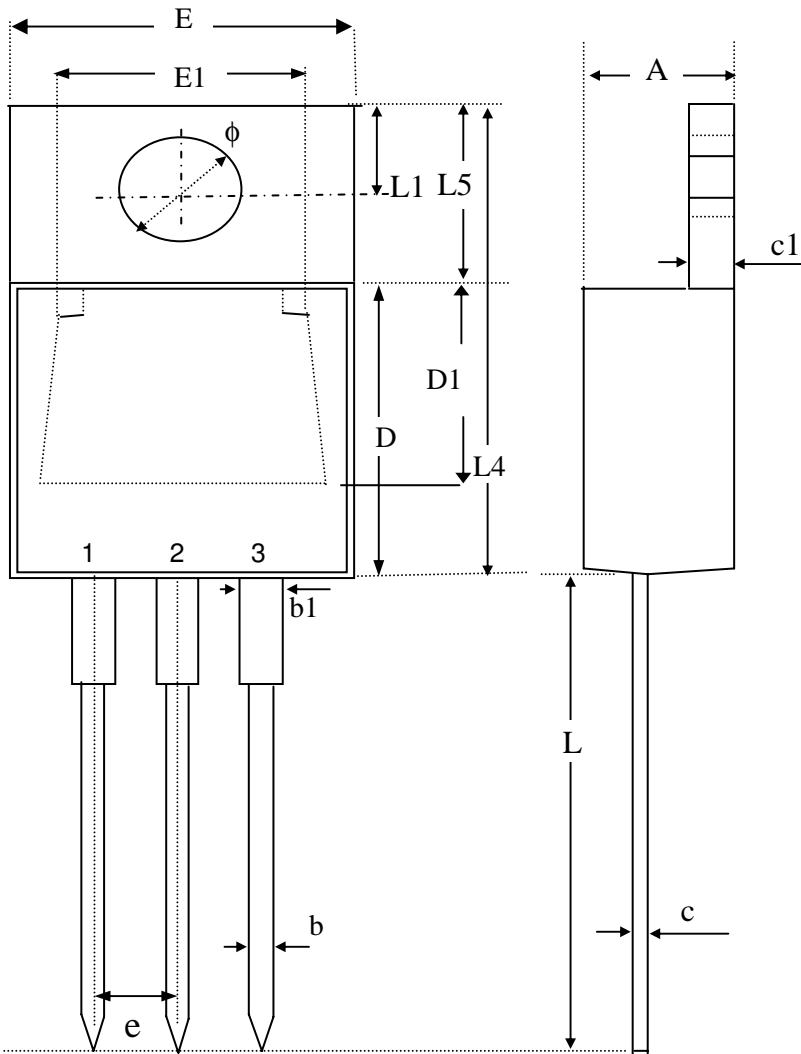


Fig 12. SOA Characteristics



Package Dimensions: TO-220



SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	4.40	4.60	4.80
b	0.76	0.88	1.00
D	8.60	8.80	9.00
c	0.36	0.43	0.50
E	9.80	10.10	10.40
L4	14.70	15.00	15.30
L5	6.20	6.40	6.60
D1	5.10 REF.		
c1	1.25	1.35	1.45
b1	1.17	1.32	1.47
L	13.25	13.75	14.25
e	2.54 REF.		
L1	2.60	2.75	2.89
phi	3.71	3.84	3.96
E1	7.4 REF.		

1. All dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

Marking Information:

